



SURFACE MOUNT FAST SWITCHING DIODE ARRAY

Features

- Fast Switching Speed
- Low Forward Voltage: Maximum of 0.72V at 5mA
- Low Reverse Current: Maximum of 100nA at 70V
- Fast Reverse Recovery: Maximum of 4ns
- Low Capacitance: Maximum of 3.5pF
- Small Surface Mount Package
- For General Purpose Switching Applications

SOT-363

TOP VIEW

- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT353 or SOT363
 - Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 @3)
- Orientation: See Diagrams Below
- Weight: 0.006 grams (approximate)

SOT353/SOT363



SOT-353

TOP VIEW







Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging		
MMBD4448HADW-7-F	Commercial	SOT363	3000/Tape & Reel		
MMBD4448HADWQ-7-F	Automotive	SOT363	3000/Tape & Reel		
MMBD4448HAQW-7-F	Commercial	SOT363	3000/Tape & Reel		
MMBD4448HCDW-7-F	Commercial	SOT363	3000/Tape & Reel		
MMBD4448HCQW-7-F	Commercial	SOT353	3000/Tape & Reel		
MMBD4448HSDW-7-F	Commercial	SOT363	3000/Tape & Reel		
MMBD4448HTW-7-F	Commercial	SOT363	3000/Tape & Reel		

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



KA4 = Product Type Marking Code, KA4 = MMBD4448HCQW YM = Date Code Marking Y = Year (ex: Z = 2012)M = Month (ex: 9 = September)

KXX YΜ MΥ **XXX** SOT-363

KXX = Product Type Marking Code, ex. KA6 = MMBD4448HADW

KA7 = MMBD4448HCDW KAB = MMBD4448HSDW YM = Date Code Marking Y = Year (ex: Z = 2012)M = Month (ex: 9 = September)



KXX = Product Type Marking Code, ex. KA5 = MMBD4448HAQW KAA = MMBD4448HTW YM = Date Code Marking Y = Year (ex: Z = 2012)M = Month (ex: 9 = September)

Date	Code	Key

I	Year	2000	2001	2002	2003		2012	201	3 201	4 201	5 2016	2017	2018	2019
	Code	L	М	Ν	Р		Z	A	В	С	D	E	F	G
ſ	Month	Jan	Feb	Mar	Apr	Ма	iy J	Jun	Jul	Aug	Sep	Oct	Nov	Dec
ſ	Code	1	2	3	4	5		6	7	8	9	0	N	D

MMBD4448HCQW /AQW /ADW /CDW /SDW /TW

Document number: DS30153 Rev. 18 - 2



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Non-Repetitive Peak Reverse Voltage		V _{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	80	V
RMS Reverse Voltage		V _{R(RMS)}	57	V
Forward Continuous Current (Note 5)		I _{FM}	500	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I _{FSM}	4.0 1.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 5)	$R_{ ext{ heta}JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	80		V	I _R = 100μA
		0.62	0.72		I _F = 5.0mA
Forward Voltage	¥-	_	0.855	V	$I_F = 10 \text{mA}$
Forward voltage	VF		1.0	v	I _F = 100mA
		_	1.25		I _F = 150mA
			100	nA	V _R = 70V
Reverse Current (Note 6)			50	μA	V _R = 75V, T _J = +150°C
Reverse Current (Note 6)	I _R	_	30	μA	V _R = 25V, T _J = +150°C
			25	nA	V _R = 20V
Total Capacitance	CT		3.5	pF	$V_{R} = 6V, f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	4.0	ns	$V_{R} = 6V, I_{F} = 5mA$

Notes:

5. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com.

6. Short duration pulse test used to minimize self-heating effect.





MMBD4448HCQW /AQW /ADW /CDW /SDW /TW Document number: DS30153 Rev. 18 - 2



MMBD4448HCQW /AQW /ADW /CDW /SDW /TW





Figure 4 Total Capacitance vs. Reverse Voltage

Package Outline Dimensions



MMBD4448HCQW /AQW /ADW /CDW /SDW /TW Document number: DS30153 Rev. 18 - 2



Suggested Pad Layout



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2012, Diodes Incorporated

www.diodes.com